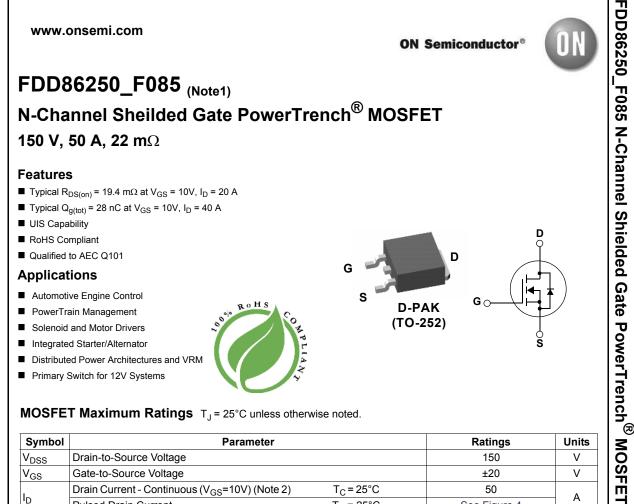
**ON Semiconductor** 

Is Now

# Onsemi

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Symbol	Parameter		Ratings	Units	
V <sub>DSS</sub>	Drain-to-Source Voltage		150	V	
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V	
I <sub>D</sub>	Drain Current - Continuous (V <sub>GS</sub> =10V) (Note 2)	T <sub>C</sub> =25°C	50	•	
	Pulsed Drain Current	T <sub>C</sub> = 25°C	See Figure 4	A	
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 3)	80	mJ	
P <sub>D</sub>	Power Dissipation		160	W	
	Derate Above 25°C		1.06	W/ <sup>o</sup> C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to + 175	°C	
₹ <sub>θJC</sub>	Thermal Resistance, Junction to Case		0.94	°C/W	
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 4)	40	°C/W	

## Notes:

1: Due to system integration constraints between Fairchild and ON semiconductor, as of November 1, 2017 any product part number with a underscore will be replaced with a dash. This is a notification.

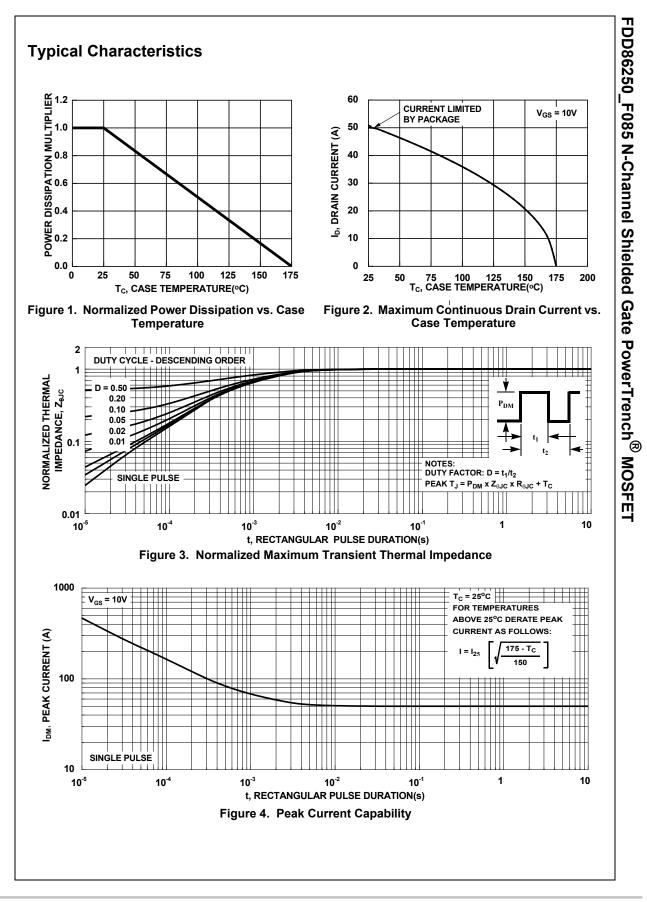
Current is limited by bondwire configuration.
 Starting T<sub>J</sub> = 25°C, L = 0.1mH, I<sub>AS</sub> = 40A, V<sub>DD</sub> = 135V during inductor charging and V<sub>DD</sub> = 0V during time in avalanche.

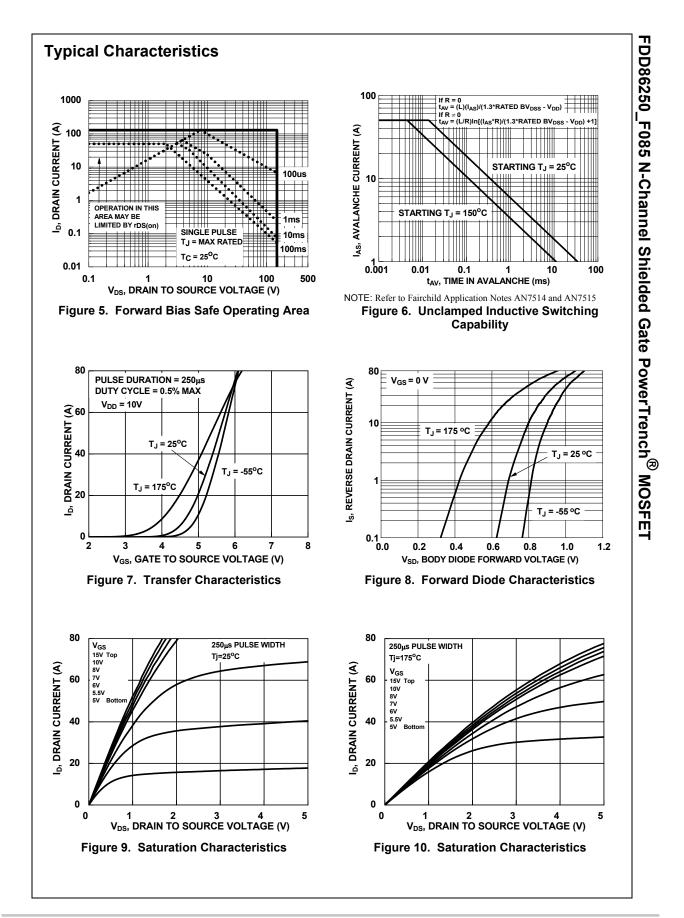
4: R<sub>0JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta,JC}$  is guaranteed by design, while  $R_{\theta,JA}$  is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

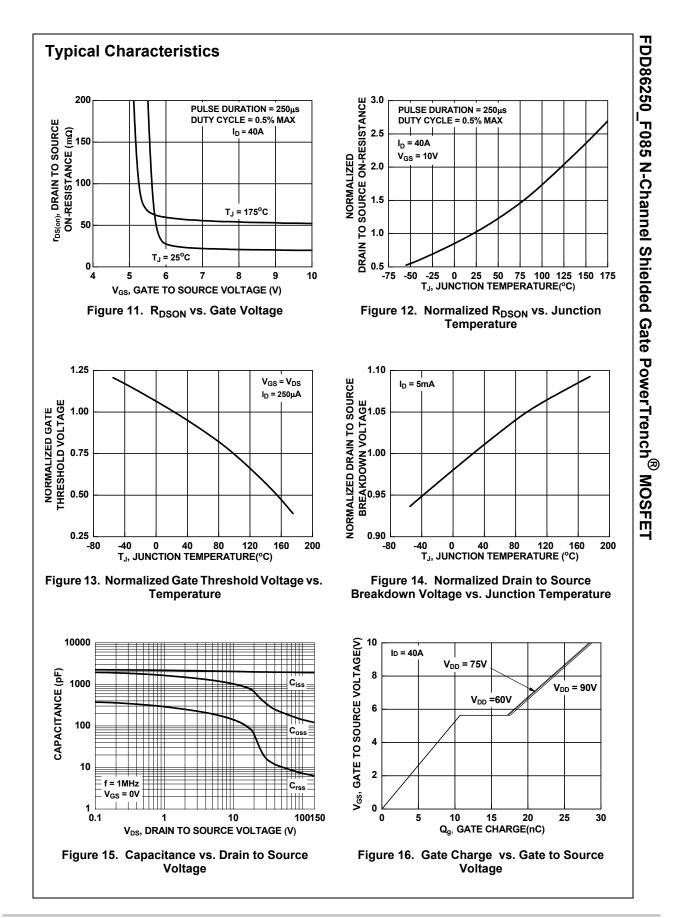
# Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD86250	FDD86250_F085	D-PAK(TO-252)	13"	16mm	2500units

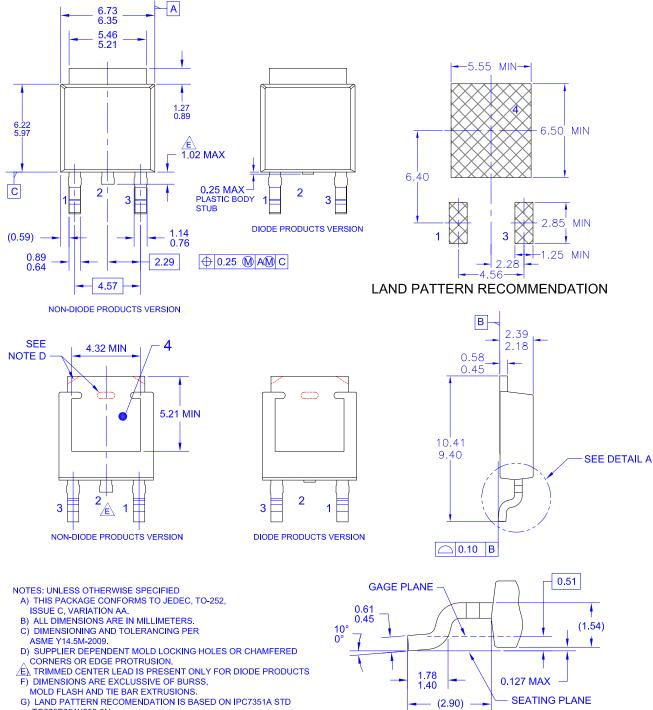
	Parameter	Test Conditions		Min.	Тур.	Max.	Units
Off Cha	aracteristics						
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V		150	-	-	V
	Drain to Course Looke to Current	V <sub>DS</sub> = 150V		-	-	1	μA
I <sub>DSS</sub>	Drain-to-Source Leakage Current	$V_{GS} = 0V$	T <sub>J</sub> = 175 <sup>o</sup> C (Note 5)	-	-	1	mA
I <sub>GSS</sub>	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA
On Cha	racteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$		2	3	4	V
R <sub>DS(on)</sub>	Drain to Source On Resistance	$I_{\rm D} = 20$ A, $T_{\rm J} = 25^{\circ}$ C		-	19.4	22	mΩ
		$V_{GS} = 10V$	-	-	56	62	mΩ
C <sub>iss</sub>	Input Capacitance			-	1900	-	pF
C <sub>oss</sub>	Output Capacitance	─ V <sub>DS</sub> = 75V, \ f = 1MHz	/ <sub>GS</sub> = 0V,	-	169	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 110112		-	10	-	pF
R <sub>g</sub>	Gate Resistance	f = 1MHz		-	0.5	-	Ω
Q <sub>g(ToT)</sub>	Total Gate Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DD} = 120V$ $V_{GS} = 0 \text{ to } 2V$ $I_D = 40A$		-	28	37	nC
Q <sub>g(th)</sub>	Threshold Gate Charge			-	4	-	nC
Q <sub>gs</sub>	Gate-to-Source Gate Charge			-	11	-	nC
Q <sub>gd</sub>	Gate-to-Drain "Miller" Charge			-	7	-	nC
Switchi	ng Characteristics				1		T
	Turn-On Time		-	-		64	ns
t <sub>on</sub>				-	14	-	ns
t <sub>d(on)</sub>	Turn-On Delay		-				
t <sub>d(on)</sub>	Turn-On Delay Rise Time	V <sub>DD</sub> = 75V, I	l <sub>D</sub> = 40A,	-	34	-	ns
t <sub>on</sub> t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Turn-On Delay       Rise Time       Turn-Off Delay	V <sub>DD</sub> = 75V, V <sub>GS</sub> = 10V,	l <sub>D</sub> = 40A, R <sub>GEN</sub> = 6Ω	-	34 23	-	ns ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-On DelayRise TimeTurn-Off DelayFall Time	V <sub>DD</sub> = 75V, V <sub>GS</sub> = 10V,	l <sub>D</sub> = 40A, R <sub>GEN</sub> = 6Ω		34 23 5	-	ns ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-On Delay       Rise Time       Turn-Off Delay	V <sub>DD</sub> = 75V, V <sub>GS</sub> = 10V,	l <sub>D</sub> = 40A, R <sub>GEN</sub> = 6Ω	-	34 23	-	ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> t <sub>off</sub>	Turn-On DelayRise TimeTurn-Off DelayFall Time	V <sub>DD</sub> = 75V, 1 V <sub>GS</sub> = 10V,	l <sub>D</sub> = 40A, R <sub>GEN</sub> = 6Ω	-	34 23 5	-	ns ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> t <sub>off</sub> <b>Drain-S</b>	Turn-On Delay         Rise Time         Turn-Off Delay         Fall Time         Turn-Off Time         Source Diode Characteristics	V <sub>GS</sub> = 10V,	R <sub>GEN</sub> = 6Ω / <sub>GS</sub> = 0V	-	34 23 5	- - 37 1.25	ns ns ns V
$rac{t_{d(on)}}{t_r}$ $rac{t_r}{t_d(off)}$ $rac{t_d(off)}{t_off}$ Drain-S $V_{SD}$	Turn-On Delay         Rise Time         Turn-Off Delay         Fall Time         Turn-Off Time         Source Diode Characteristics         Source-to-Drain Diode Voltage	V <sub>GS</sub> = 10V,	$R_{GEN} = 6\Omega$ $M_{GS} = 0V$ $M_{GS} = 0V$	-	34 23 5 - 0.9 0.8	- - 37 1.25 1.2	ns ns ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>off</sub> Drain-S	Turn-On Delay         Rise Time         Turn-Off Delay         Fall Time         Turn-Off Time         Source Diode Characteristics	V <sub>GS</sub> = 10V,	$R_{GEN} = 6\Omega$ $r'_{GS} = 0V$ $r'_{GS} = 0V$ $r'_{GS} = 0V$ $r'_{F} = 40A$ ,		34 23 5 -	- - 37 1.25	ns ns ns V







DPAK3 (TO-252 3 LD) CASE 369AS ISSUE O



(2.90)

DETAIL A (ROTATED 90°) SCALE: 12X

TO228P991X239-3N.

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